

3A, 1MHz, Synchronous Step-Down Converter

General Description

The RT8068A is a high efficiency synchronous, step-down DC-DC converter. It's input voltage range from 2.7V to 5.5V that provides an adjustable regulated output voltage from 0.6V to V_{IN} while delivering up to 3A of output current. The internal synchronous low on resistance power switches increase efficiency and eliminate the need for an external Schottky diode. The switching frequency is fixed internally at 1MHz. The 100% duty cycle provides low dropout operation, hence extending battery life in portable systems. Current mode operation with internal compensation allows the transient response to be optimized over a wide range of loads and output capacitors. The RT8068A is available in WDFN-10L 3x3 and SOP-8 (Exposed Pad) packages.

Ordering Information

RT8068A

Package Type

QW: WDFN-10L 3x3 (W-Type) SP: SOP-8 (Exposed Pad-Option 2)

Lead Plating System

Z : ECO (Ecological Element with Halogen Free and Pb free)

Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information

RT8068AZQW

13 YM DNN 13 : Product Code YMDNN : Date Code

RT8068AZSP

RT8068A ZSPYMDNN RT8068AZSP: Product Code

YMDNN: Date Code

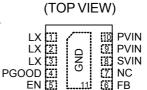
Features

- High Efficiency: Up to 95%
- Low R_{DS(ON)} Internal Switches : $69m\Omega/49m\Omega$ at V_{IN} = 5V
- Fixed Frequency: 1MHz
- No Schottky Diode Required
- Internal Compensation
- 0.6V Reference Allows Low Output Voltage
- Low Dropout Operation: 100% Duty Cycle
- OCP, UVP, OVP, OTP
- RoHS Compliant and Halogen Free

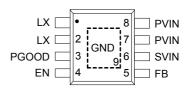
Applications

- Portable Instruments
- Battery Powered Equipment
- Notebook Computers
- Distrib uted Power Systems
- IP Phones
- Digital Cameras

Pin Configuration



WDFN-10L 3x3



SOP-8 (Exposed Pad)

Copyright ©2019 Richtek Technology Corporation. All rights reserved.
RICHTEK is a registered trademark of Richtek Technology Corporation.



Typical Application Circuit

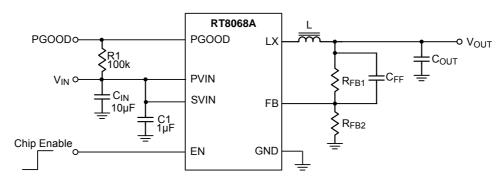


Table 1. Recommended Component Selection

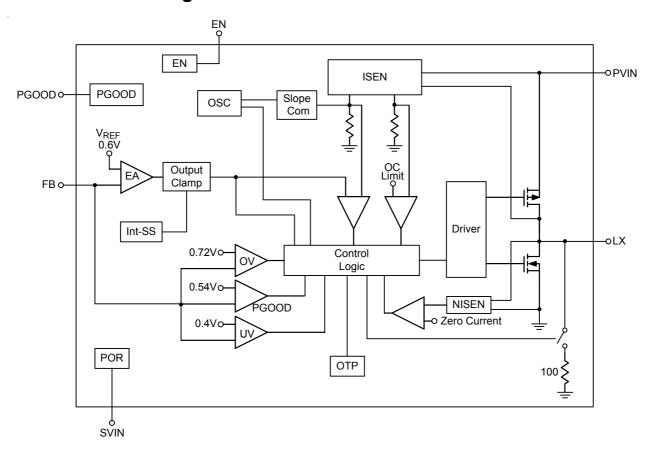
V _{OUT} (V)	R_{FB1} ($k\Omega$)	R_{FB2} (k Ω)	C _{FF} (pF)	L (μ H)	C _{OUT} (μF)
3.3	229.5	51	22	2	22 x 2
2.5	161.5	51	22	2	22 x 2
1.8	102	51	22	1.5	22 x 2
1.5	76.5	51	22	1.5	22 x 2
1.2	51	51	22	1.5	22 x 2
1.0	34	51	22	1.5	22 x 2

Functional Pin Description

Pin No.		Pin			
WDFN-10L	SOP-8 (Exposed Pad)	Name	Pin Function		
1, 2, 3	1, 2	LX	Switch node. Connect this pin to the inductor.		
4	3	PGOOD	Power good indicator. This pin is an open drain logic output that is pulled to ground when the output voltage is less than 90% of the target output voltage. Hysteresis = 5%.		
5	4	EN	Enable control. Pull high to turn on. Do not float.		
6	5	FB	Feedback pin. This pin receives the feedback voltage from a resistive voltage divider connected across the output.		
7		NC	No internal connection.		
8	6	SVIN	Signal input pin. Decouple this pin to GND with at least $1\mu\text{F}$ ceramic cap.		
9,10	7,8	PVIN	Power input pin. Decouple this pin to GND with at least $4.7\mu\text{F}$ ceramic cap.		
11 (Exposed Pad)	9 (Exposed Pad)	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.		



Functional Block Diagram





Absolute Maximum Ratings (Note 1)

Supply Input Voltage, PVIN, SVIN	–0.3V to 6.5V
• LX Pin	
DC	0.3V to (VIN + 0.3V)
< 100ns	–2.5V to 9V
Other I/O Pin Voltage	–0.3V to 6.5V
 Power Dissipation, P_D @ T_A = 25°C 	
WDFN-10L 3x3	1.429W
SOP-8 (Exposed Pad)	1.333W
Package Thermal Resistance (Note 2)	
WDFN-10L 3x3, θ_{JA}	70°C/W
WDFN-10L 3x3, θ_{JC}	8.2°C/W
SOP-8 (Exposed Pad), θ _{JA}	75°C/W
SOP-8 (Exposed Pad), θ _{JC}	15°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
Junction Temperature	150°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
MM (Machine Model)	200V

Recommended Operating Conditions (Note 4)

- Supply Input Voltage, PVIN, SVIN------ 2.7V to 5.5V
- Junction Temperature Range ----- -10°C to 105°C

Electrical Characteristics

 $(V_{IN} = 5.5V, T_A = 25^{\circ}C, unless otherwise specified)$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Feedback Reference Voltage	V _{REF}		0.594	0.6	0.606	V
Feedback Leakage Current	I _{FB}			0.1	0.4	μΑ
DC Bias Current		Active , V _{FB} = 0.7V, not switching	1	110	140	μА
		Shutdown			1	
Output Voltage Line Regulation		V _{IN} = 2.7V to 5.5V I _{OUT} = 0A		0.3		%/V
Output Voltage Load Regulation		(Note 5)	-1		1	%
Switch Leakage Current					1	μΑ
Switching Frequency			0.8	1	1.2	MHz
Switch On Resistance, High	R _{DS(ON)} P			69		mΩ
Switch On Resistance, Low	R _{DS(ON)_N}			49		mΩ
P-MOSFET Current Limit	I _{LIM}		4			Α

www.richtek.com

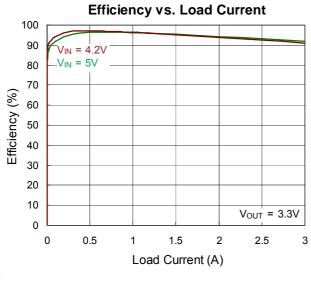


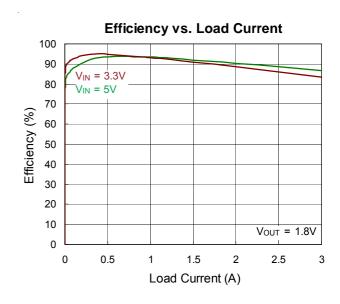
Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit	
Under-Voltage Lockout		V _{UVLO}	V _{IN} rising	2.2	2.4	2.6	V	
Threshold			V _{IN} falling	2	2.2	2.4		
EN Input	Logic-High	ViH		1.6			V	
Threshold Voltage	Logic-Low	VIL				0.4		
EN Pull Low Resistance					500		kΩ	
Over-Temperature	Protection	T _{SD}			150		°C	
Over-Temperature Protection Hysteresis					20		°C	
Soft-Start Time		tss		500			μS	
V _{OUT} Discharge Re	esistance				100		Ω	
V _{OUT} Over-Voltage Protection (Latch-Off, Delay Time = 10μs)				115	120	130	%	
V _{OUT} Under-Voltage Lock Out (Latch-Off)				57	66	75	%	
Power Good			Measured FB, with respect to V _{REF}	85	90		%	
Power Good Hysteresis					5		%	

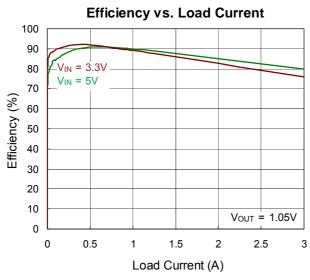
- **Note 1.** Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at T_A = 25°C on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Guaranteed by design.

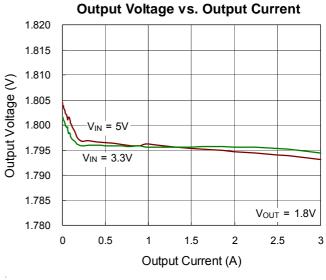


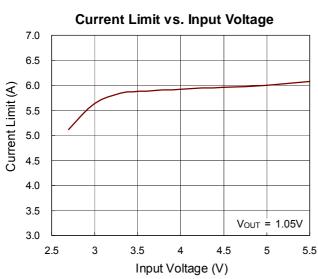
Typical Operating Characteristics

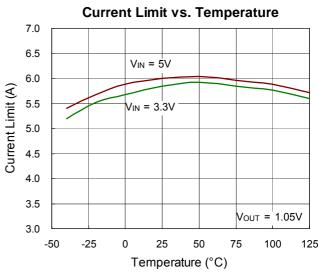






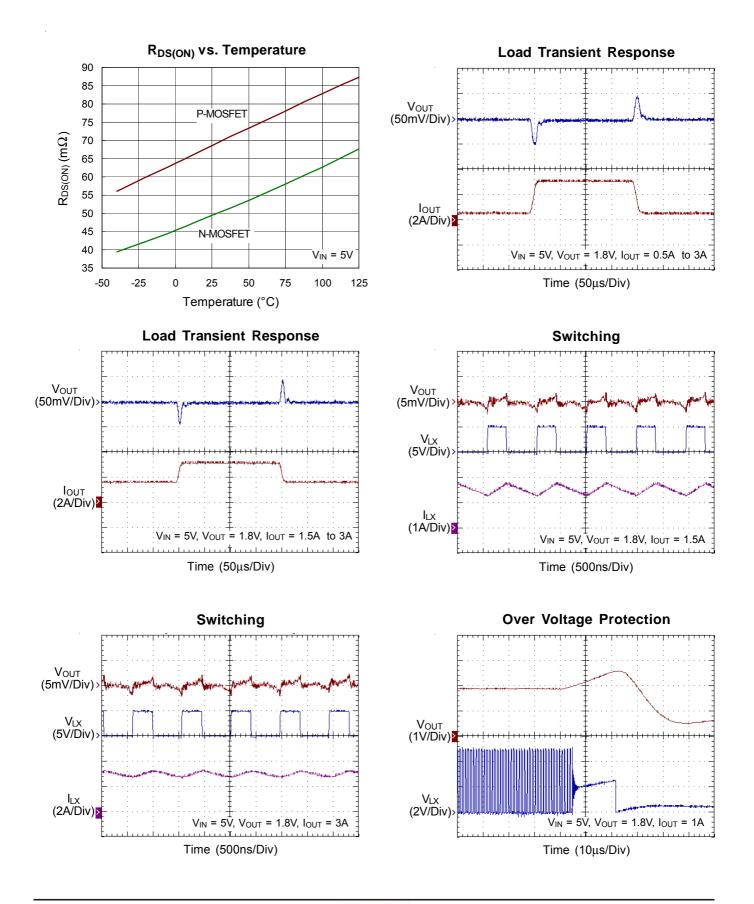






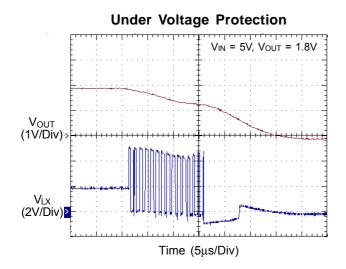
Copyright ©2019 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.

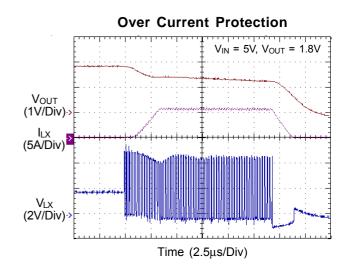


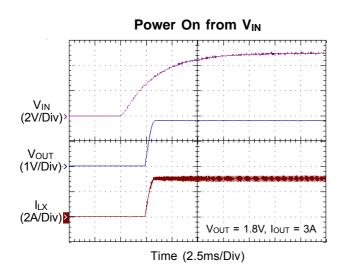


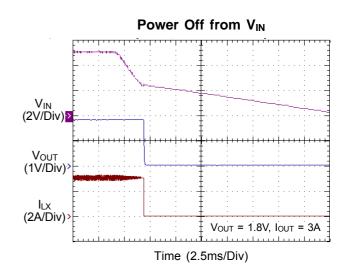
Copyright ©2019 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.

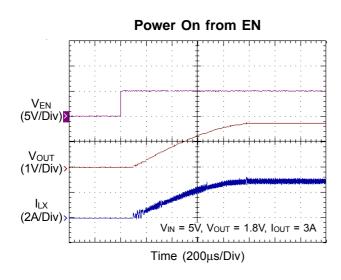


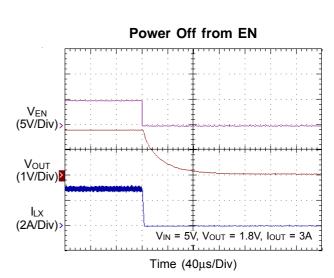












Copyright ©2019 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.



Application Information

The RT8068A is a single-phase buck converter. It provides single feedback loop, current mode control with fast transient response. An internal 0.6V reference allows the output voltage to be precisely regulated for low output voltage applications. A fixed switching frequency (1MHz) oscillator and internal compensation are integrated to minimize external component count. Protection features include over-current protection, under-voltage protection, over-voltage protection and over-temperature protection.

Output Voltage Setting

Connect a resistive voltage divider at the FB between V_{OUT} and GND to adjust the output voltage. The output voltage is set according to the following equation :

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R_{FB1}}{R_{FB2}}\right)$$
 where V_{REF} is 0.6V (typ.).

Figure 1. Setting V_{OUT} with a Voltage Divider

Chip Enable and Disable

The EN pin allows for power sequencing between the controller bias voltage and another voltage rail. The RT8068A remains in shutdown if the EN pin is lower than 400mV. When the EN pin rises above the V_{EN} trip point, the RT8068A begins a new initialization and soft-start cycle.

Internal Soft-Start

The RT8068A provides an internal soft-start function to prevent large inrush current and output voltage overshoot when the converter starts up. The soft-start (SS) automatically begins once the chip is enabled. During soft-start, the internal soft-start capacitor becomes charged and generates a linear ramping up voltage across the capacitor. This voltage clamps the voltage at the FB pin, causing PWM pulse width to increase slowly and in turn reduce the output surge current. The internal 0.6V reference takes over the loop control once the internal ramping-up voltage becomes higher than 0.6V.

UVLO Protection

The RT8068A has input under voltage lockout protection (UVLO). If the input voltage exceeds the UVLO rising threshold voltage (2.4V typ.), the converter resets and prepares the PWM for operation. If the input voltage falls below the UVLO falling threshold voltage during normal operation, the device will stop switching. The UVLO rising and falling threshold voltage has a hysteresis to prevent noise-caused reset.

Inductor Selection

The switching frequency (on-time) and operating point (% ripple or LIR) determine the inductor value as shown below:

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{f_{SW} \times LIR \times I_{LOAD(MAX)} \times V_{IN}}$$

where LIR is the ratio of the peak-to-peak ripple current to the average inductor current.

Find a low loss inductor having the lowest possible DC resistance that fits in the allotted dimensions. Ferrite cores are often the best choice, although powdered iron is inexpensive and can work well at 200 kHz. The core must be large enough not to saturate at the peak inductor current (I_{PEAK}):

$$I_{PEAK} = I_{LOAD(MAX)} + \left(\frac{LIR}{2} \times I_{LOAD(MAX)}\right)$$

The calculation above serves as a general reference. To further improve transient response, the output inductor can be further reduced. This relation should be considered along with the selection of the output capacitor.

Input Capacitor Selection

High quality ceramic input decoupling capacitor, such as X5R or X7R, with values greater than $20\mu F$ are recommended for the input capacitor. The X5R and X7R ceramic capacitors are usually selected for power regulator capacitors because the dielectric material has less capacitance variation and more temperature stability.

Voltage rating and current rating are the key parameters when selecting an input capacitor. Generally, selecting an input capacitor with voltage rating 1.5 times greater than the maximum input voltage is a conservatively safe design.

Copyright ©2019 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.

DS8068A-08 June 2019



The input capacitor is used to supply the input RMS current, which can be approximately calculated using the following equation:

$$I_{\text{IN_RMS}} = I_{\text{LOAD}} \times \sqrt{\frac{V_{\text{OUT}}}{V_{\text{IN}}}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right)$$

The next step is selecting a proper capacitor for RMS current rating. One good design is using more than one capacitor with low equivalent series resistance (ESR) in parallel to form a capacitor bank.

The input capacitance value determines the input ripple voltage of the regulator. The input voltage ripple can be approximately calculated using the following equation:

$$\Delta V_{IN} = \frac{I_{OUT(MAX)} \times 0.25}{C_{IN} \times f_{SW}}$$

For example, if $I_{OUT\ MAX}$ = 3A, C_{IN} = $20\mu F$, f_{SW} = 1MHz, the input voltage ripple will be 37.5mV.

Output Capacitor Selection

The output capacitor and the inductor form a low pass filter in the buck topology. In steady state condition, the ripple current flowing into/out of the capacitor results in ripple voltage. The output voltage ripple (V_{P-P}) can be calculated by the following equation:

$$V_{P_P} = LIR \times I_{LOAD(MAX)} \times \left(ESR + \frac{1}{8 \times C_{OUT} \times f_{SW}}\right)$$

When load transient occurs, the output capacitor supplies the load current before the controller can respond. Therefore, the ESR will dominate the output voltage sag during load transient. The output voltage undershoot (V_{SAG}) can be calculated by the following equation:

$$V_{SAG} = \Delta I_{LOAD} \times ESR$$

For a given output voltage sag specification, the ESR value can be determined.

Another parameter that has influence on the output voltage sag is the equivalent series inductance (ESL). The rapid change in load current results in di/dt during transient. Therefore, the ESL contributes to part of the voltage sag. Using a capacitor with low ESL can obtain better transient performance. Generally, using several capacitors connected in parallel can have better transient performance than using a single capacitor for the same total ESR.

Unlike the electrolytic capacitor, the ceramic capacitor has relatively low ESR and can reduce the voltage deviation during load transient. However, the ceramic capacitor can only provide low capacitance value. Therefore, use a mixed combination of electrolytic capacitor and ceramic capacitor to obtain better transient performance.

Power Good Output (PGOOD)

PGOOD is an open-drain type output and requires a pullup resistor. PGOOD is actively held low in soft-start, standby, and shutdown. It is released when the output voltage rises above 90% of nominal regulation point. The PGOOD signal goes low if the output is turned off or is 10% below its nominal regulation point.

Under-Voltage Protection (UVP)

The output voltage can be continuously monitored for under voltage. When under-voltage protection is enabled, both UGATE and LGATE gate drivers will be forced low if the output is less than 66% of its set voltage threshold. The UVP will be ignored for at least 3ms (typ.) after start up or a rising edge on the EN threshold. Toggle EN threshold or cycle V_{IN} to reset the UVP fault latch and restart the controller.

Over-Voltage Protection (OVP)

The RT8068A is latched once OVP is triggered and can only be released by toggling EN threshold or cycling V_{IN}. There is a 10µs delay built into the over-voltage protection circuit to prevent false transition.

Over-Current Protection (OCP)

The RT8068A provides over-current protection by detecting high-side MOSFET peak inductor current. If the sensed peak inductor current is over the current limit threshold (4A typ.), the OCP will be triggered. When OCP is tripped, the RT8068A will keep the over current threshold level until the over current condition is removed.

Internal Output Voltage Discharge

An internal open-drain logic output is implemented on LX pin. During the conditions of OVP, UVP, OTP and enable low, the internal discharge path is activated and the left energy from output terminal is able to be released with an internal resistance about 100Ω to ground.

www.richtek.com



Thermal Shutdown (OTP)

The device implements an internal thermal shutdown function when the junction temperature exceeds 150°C. The thermal shutdown forces the device to stop switching when the junction temperature exceeds the thermal shutdown threshold. Once the die temperature decreases below the hysteresis of 20°C, the device reinstates the power up sequence.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C and T_A is the ambient temperature. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For SOP-8 (Exposed Pad) packages, the thermal resistance, θ_{JA} , is 75°C/W on a standard JEDEC 51-7 four-layer thermal test board. For WDFN-10L 3x3 packages, the thermal resistance, θ_{JA} . is 70°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by the following formulas:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (75^{\circ}C/W) = 1.333W$ for SOP-8 (Exposed Pad) package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (70^{\circ}C/W) = 1.429W$ for WDFN-10L 3x3 package

The maximum power dissipation depends on the operating ambient temperature for fixed T_{J(MAX)} and thermal resistance, θ_{JA} . For the RT8068A package, the derating curves in Figure 2 allow the designer to see the effect of rising ambient temperature on the maximum power dissipation.

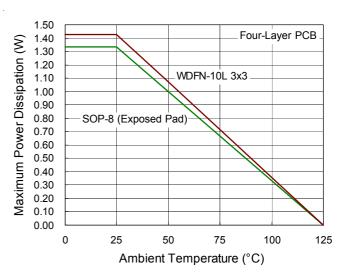


Figure 2. Derating Curve of Maximum Power Dissipation

Layout Considerations

Layout is very important in high frequency switching converter design. The PCB can radiate excessive noise and contribute to converter instability with improper layout. Certain points must be considered before starting a layout using the RT8068A.

- Make the traces of the main current paths as short and wide as possible.
- Put the input capacitor as close as possible to the device pins (V_{IN} and GND).
- LX node encounters high frequency voltage swings so it should be kept in a small area. Keep sensitive components away from the LX node to prevent stray capacitive noise pick-up.
- Ensure all feedback network connections are short and direct. Place the feedback network as close to the chip as possible.
- ▶ The GND pin and Exposed Pad should be connected to a strong ground plane for heat sinking and noise protection.
- An example of PCB layout guide is shown in Figure 3. for reference.

Copyright ©2019 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.

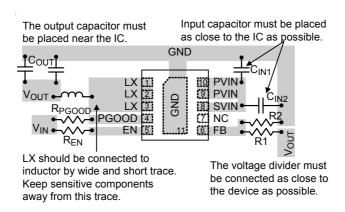
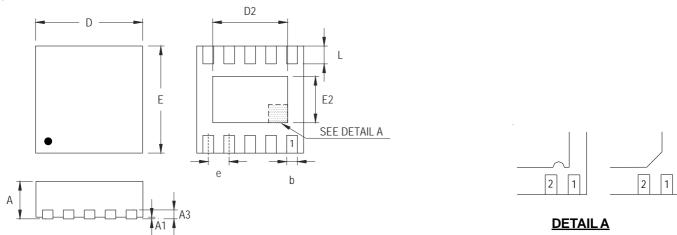


Figure 3. PCB Layout Guide



Outline Dimension



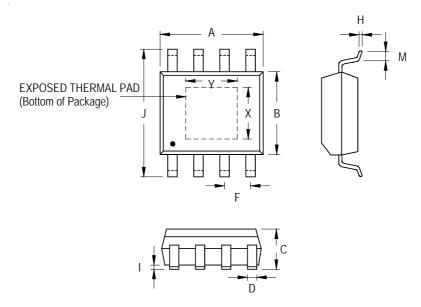
Pin #1 ID and Tie Bar Mark Options

Note: The configuration of the Pin#1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.175	0.250	0.007	0.010	
b	0.180	0.300	0.007	0.012	
D	2.950	3.050	0.116	0.120	
D2	2.300	2.650	0.091	0.104	
Е	2.950	3.050	0.116	0.120	
E2	1.500	1.750	0.059	0.069	
е	0.500		0.0)20	
L	0.350	0.450	0.014	0.018	

W-Type 10L DFN 3x3 Package





Symbol		Dimensions	In Millimeters	Dimensions In Inches		
		Min	Max	Min	Max	
Α		4.801	5.004	0.189	0.197	
В		3.810	4.000	0.150	0.157	
С		1.346	1.753	0.053	0.069	
D		0.330	0.510	0.013	0.020	
F		1.194	1.346	0.047	0.053	
Н		0.170	0.254	0.007	0.010	
I		0.000	0.152	0.000	0.006	
J		5.791	6.200	0.228	0.244	
М		0.406	1.270	0.016	0.050	
Ontion 1	Х	2.000	2.300	0.079	0.091	
Option 1	Υ	2.000	2.300	0.079	0.091	
Ontion 2	Х	2.100	2.500	0.083	0.098	
Option 2	Υ	3.000	3.500	0.118	0.138	

8-Lead SOP (Exposed Pad) Plastic Package

Richtek Technology Corporation

14F, No. 8, Tai Yuen 1st Street, Chupei City Hsinchu, Taiwan, R.O.C.

Tel: (8863)5526789

Richtek products are sold by description only. Customers should obtain the latest relevant information and data sheets before placing orders and should verify that such information is current and complete. Richtek cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Richtek product. Information furnished by Richtek is believed to be accurate and reliable. However, no responsibility is assumed by Richtek or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Richtek or its subsidiaries.

www.richtek.com

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Isolated DC/DC Converters category:

Click to view products by Richtek manufacturer:

Other Similar products are found below:

ESM6D044440C05AAQ FMD15.24G PSL486-7LR PSR152.5-7IR Q48T30020-NBB0 AVO240-48S12B-6L AVO250-48S28B-6L NAN-0505 HW-L16D JAHW100Y1 217-1617-001 22827 SPB05C-12 SQ24S15033-PS0S 18952 19-130041 CE-1003 CE-1004 GQ2541-7R PSE1000DCDC-12V RDS180245 MAU228 419-2065-201 449-2075-101 TME 03038 TME 0505S TME 1205S TME 1212S TME 2405S TME 2412S V300C24C150BG 419-2062-200 419-2063-401 419-2067-101 419-2067-501 419-2068-001 DCG40-5G DFC15U48D15 449-2067-000 XGS-0512 XGS-1205 XGS-1212 XGS-2412 XGS-2415 XKS-1215 033456 NCT1000N040R050B SPB05B-15 SPB05C-15 TME 0509S